### **Overview**

### **HP EliteBook 835 G7 Notebook PC**



### Left

- 1. Ambient Light Sensor (Optional)
- 2. Internal microphones (2)
- 3. Webcam LED (Optional)
- 4. Camera Shutter
- 5. HD and IR Camera (Optional)
- 6. IR Camera LEDs (Optional)

- 7. Glass Clickpad
- 8. Smartcard Reader (Optional)
- 9. Audio Combo Jack
- **10.** USB 3.1 Gen 1 Port
- 11. USB 3.1 Gen 1 Port Charging Port
- 12. Nano Security Lock Slot (Lock sold separately)

## **Overview**



### Right

- 1. Power Button Key
- 2. Power Connector
- 3. HDMI port (Cable not included)
- 4. USB-C® (Alt Mode, 3.1 Gen2)

- 5. USB-C® (Alt Mode, 3.1 Gen2)
- 6. Nano Sim
- 7. HP Fingerprint Sensor (select models)

1. All units have a SIM card stray but units that do not support WWAN are shipped with a non-removable SIM slot plug

### Overview

### **AT A GLANCE**

- Preinstall Windows 10, FreeDOS 3.0
- AMD® Ryzen Pro 4000 processors
- Display include your choice of 33.8cm (13") diagonal IPS Wide viewing Angle, FHD or UHD, Touch or Non-Touch
- AMD Radeon™ Graphics
- Enterprise grade security with HP Sure Sense<sup>4</sup>, HP SureStart Gen6, HP Privacy Camera, HP Sure View Reflect<sup>1</sup>, HP Sure Run Gen3 HP Sure Recover Gen3, HP Sure Click, SmartCard Reader<sup>2</sup> and Touch Fingerprint reader<sup>5</sup> (select models)
- Tested for 19 MIL-STD 810H tests<sup>3</sup>
- Weight starting at 2.78 lb (1.26 kg)
- Battery life up to 24 and 15 minutes hours
- Supports wireless LAN and wireless WAN options for connectivity on the go
- Up to 1 TB Solid State Drives
- Up to 32 GB total system memory
- 720p HD webcam, IR camera for face authentication with Windows Hello
- Full size, backlit, Keyboard and Clickpad with image sensor and glass surface, multi-touch gestures enabled, taps enabled as default
- Designed to support USB-C<sup>®</sup> and Thunderbolt HP docking options including the HP Universal Dock G5<sup>2</sup>
- Enables AMD Memory Guard to help defend against cold boot attacks with real-time encryption and decryption of system's memory
- Support HP Sure View Reflect with Optional 1000 nit Anti-Glare Privacy Screen which prevents visual hacking
- 1. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation
- 2. Sold separately or as an optional feature
- 3. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
- 4. HP Sure Sense requires Windows 10. See product specifications for availability.
- 5. HP Fingerprint Sensor is an optional feature and requires configuration at purchase

NOTE: See important legal disclosures for all listed specs in their respective features sections.



## **Technical Specifications**

### **PRODUCT NAME**

HP EliteBook 835 G7 Notebook PC

### OPERATING SYSTEM

**Preinstalled** Windows 10 Pro 64 – HP recommends Windows 10 Pro for business<sup>1</sup>

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 641

Windows 10 Home Single Language 641

Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)<sup>1</sup>

**FreeDOS** 

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com/">http://www.windows.com/</a>.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

Note: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on <a href="https://www.support.hp.com">http://www.support.hp.com</a>. A full list of HP products and the Windows 10 versions tested is available on the HP support website <a href="https://support.hp.com/us-en/document/c05195282">https://support.hp.com/us-en/document/c05195282</a>.

HP tested Windows 10, version 1809 on this platform For testing information on newer versions of Windows 10, please see: https://support.hp.com/document/c05195282.

FreeDOS planned to be available September 2020

#### **PROCESSORS**

AMD Ryzen™ 3 PRO 4450U APU with Radeon™ Graphics (2.5 GHz base clock, up to 3.8 GHz max boost clock, 4 MB L3 cache, 4 cores)<sup>3,4,5</sup>

AMD Ryzen™ 5 PRO 4650U APU with Radeon™ Graphics (2.1 GHz base clock, up to 4 GHz max boost clock, 8 MB L3 cache, 6 cores)<sup>3,4,5</sup>

AMD Ryzen<sup>™</sup> 7 PRO 4750U APU with Radeon<sup>™</sup> Graphics (1.7 GHz base clock, up to 4.1 GHz max boost clock, 8 MB L3 cache, 8 cores)<sup>3,4,5</sup>

### **Processor Family**

2nd Gen AMD® Ryzen™ PRO processor

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on



## **Technical Specifications**

products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

### **CHIPSET**

Chipset is integrated with processor

### **GRAPHICS**

### Integrated

AMD Radeon™ Graphics<sup>6</sup>

### Supports

Support HD decode, DX12, HDMI2.0

6. HD content required to view HD images.

### **DISPLAY**

### **Non-Touch**

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC (1920 x 1080)<sup>6,7,8</sup>

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD camera (1920 x 1080) 6.7.8

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080)<sup>6,7,8</sup>

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for WWAN (1920 x 1080) 6,7,8

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD camera for WWAN (1920 x 1080)  $^{6,7,8}$ 

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD + IR camera for WWAN (1920 x 1080) 6,7,8

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare WLED-backlit bent, 1000 nits with HP Sure View Integrated Privacy Screen, 72% NTSC with Ambient Light Sensor and HD + IR camera (1920 x 1080) 6,7,8

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare WLED-backlit bent, 1000 nits with HP Sure View Integrated Privacy Screen, 72% NTSC with Ambient Light Sensor and HD + IR camera for WWAN (1920 x 1080)<sup>6,7,8,9</sup>

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare WLED-backlit bent, 400 nits, low power, 72% NTSC with Ambient Light Sensor and HD + IR camera (1920 x 1080) 6,7,8,9

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare WLED-backlit bent, 400 nits, low power, 72% NTSC with Ambient Light Sensor and HD + IR camera for WWAN (1920 x 1080) 6,7,8,9

### **Touch**

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare On-Cell WLED-backlit bent touch screen, 250 nits, 45% NTSC with HD+IR camera (1920 x 1080)<sup>6,7,8</sup>



## **Technical Specifications**

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare On-Cell WLED-backlit bent touch screen, 250 nits, 45% NTSC, for HD+IR camera for WWAN (1920  $\times$  1080)  $^{6,7,8}$ 

### **HDMI 2.0**

Support resolution up to 4K @60 Hz

- 6. HD content required to view HD images.
- 7. Sold separately or as an optional feature.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 9. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

Docking station model	Total number of supported displays (incl. the notebook) display)	Max. resolutions supported	Dock Connectors	Technicallimitations
HP Thunderbolt Dock G2	3	Dual 4K @ 60Hz	2xDP, 1xVGA, 1xUSB-C alt-mode	Dual 4k (4096 x 2160) only with:  • 1 DP + TB port or  • USB-C alt mode +  Dual 4K (3840 x 2160) with any of the DP or USB-C alt mode video ports
HP Elite USB-C Dock G5	3	Three 1680x1050 @ 60 Hz Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440)	1xHDMI, 2xDP	
HP USB-C Universal Dock G2	3	Dual 4K @ 60Hz Single 5K @ 60Hz	1xHDMI, 2xDP	
HP USB-C Travel Dock	2	Single 2K @ 60Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time

### **STORAGE AND DRIVES**

**Primary M.2 Storage** 128 GB M.2 SATA-3 TLC<sup>10</sup>



## **Technical Specifications**

256 GB PCIe® Gen3x4 NVMe<sup>™</sup> TLC Opal 2<sup>10</sup>
256 GB PCIe® Gen3x4 NVMe<sup>™</sup> SS TLC<sup>10</sup>
512 GB PCIe® Gen3x4 NVMe<sup>™</sup> M.2 SS TLC<sup>10</sup>
1 TB PCIe® Gen3 x4 NVMe<sup>™</sup> SS TLC<sup>10</sup>
256 GB PCIe® NVMe<sup>™</sup> Value<sup>10</sup>
512 GB PCIe® NVMe<sup>™</sup> Value<sup>10</sup>
512 GB PCIe® Gen3x4 NVMe<sup>™</sup> TLC Opal 2<sup>10</sup>

10. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

### **MEMORY**

### **Maximum Memory**

32 GB DDR4-3200 SDRAM

### Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB)<sup>11</sup>
16 GB DDR4-3200 SDRAM (1 x 16 GB)<sup>11</sup>
16 GB DDR4-3200 SDRAM (2 x 8 GB)<sup>11</sup>
8 GB DDR4-3200 SDRAM (1 x 8 GB)<sup>11</sup>
8 GB DDR4-3200 SDRAM (2 x 4 GB)<sup>11</sup>
4 GB DDR4-3200 SDRAM (1 x 4 GB)<sup>11</sup>

### **Memory Slots**

2 SODIMM Both slots are customer accessible / upgradeable DDR4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

11. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

### **NETWORKING/COMMUNICATIONS**



## **Technical Specifications**

#### **WLAN**

Intel® AX200 Wi-Fi 6 (2x2) and Bluetooth® 5 Combo, non-vPro™ (supporting gigabit file transfer speeds)<sup>12</sup> Realtek RTL8822BE 802.11ac (2x2) and Bluetooth® 5 Combo<sup>12</sup>

#### **WWAN**

Intel® XMM™ 7360 LTE-Advanced Cat 913

#### **NFC**

NXP NPC300 Near Field Communication Module

#### **Miracast**

Native Miracast Support<sup>14</sup>

- 12. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.
- 13. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
- 14. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

### **AUDIO/MULTIMEDIA**

#### Audio

Audio by Bang & Olufsen
2 Integrated Stereo Speakers
Integrated 3 Multi Array Microphone

#### Camera

720p HD camera<sup>6,7</sup> 720p HD+IR camera<sup>6,7,15</sup>

#### **Sensors**

Ambient light sensor (select models only)
Hall Sensor

- 6. HD content required to view HD images.
- 7. Sold separately or as an optional feature.
- 15. Internet access required.



## **Technical Specifications**

### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

### Keyboard

HP Premium Keyboard, spill resistant with drain Backlit keyboard and DuraKeys available as an option

### **Pointing Device**

Clickpad with multi-touch gestures enabled, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

### **Function Keys**

F1 - Display Switching

F2 - Blank or Privacy (with LED)

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Programmable Key

**Print Screen** 

Power Button (with LED)

### **Hidden Function Keys**

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

### **SOFTWARE AND SECURITY**

### **Preinstalled Software**

### **BIOS**

HP BIOSphere Gen5<sup>16</sup>

**HP Drive Lock & Automatic Drive Lock** 



## **Technical Specifications**

BIOS Update via Network Power On Authentication HP Secure Erase<sup>17</sup> Absolute Persistence Module<sup>18</sup> Pre-boot Authentication

#### Software

**HP Connection Optimizer** 

**HP Hotkey Support** 

**HP JumpStarts** 

HP Support Assistant<sup>19</sup>

**HP Noise Cancellation Software** 

Buy Office (sold separately)

### **Manageability Features**

HP Driver Packs (download)20

HP System Software Manager (SSM) (download)

HP BIOS Config Utility (BCU) (download)

HP Client Catalog (download)

HP Manageability Integration Kit Gen4 (download)<sup>21</sup>

**HP Image Assistant (download)** 

HP Client Management Script Library (download)

Ivanti Management Suite (download)

### **Client Security Software**

HP Client Security Manager Gen6<sup>22</sup> HP Fingerprint Sensor<sup>23</sup> Windows Defender<sup>24</sup>

### **Security Management**

**Pre-boot Authentication** 

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)<sup>25</sup> USB enable/disable (via BIOS)

Power-on password (via BIOS)

Setup password (via BIOS)

Support for chassis padlocks and cable lock devices

HP Sure Click<sup>26</sup>

HP Sure Start Gen6<sup>27</sup>

HP Sure Run Gen3<sup>28</sup>

HP Sure Recover Gen3<sup>29</sup>

HP Sure Sense<sup>30</sup>

16. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations.

17. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

18. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The



## **Technical Specifications**

Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

https://www.absolute.com/about/legal/agreements/absolute/

- 19. HP Support Assistant requires Windows and Internet access.
- 20. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 21. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.
- 22. HP Client Security Manager Gen6 requires Windows and is available on the select HP Elite and Pro PCs.
- 23. HP Fingerprint sensor is an optional feature that must be configured at purchase.
- 24. Windows Defender Opt in and internet connection required for updates.
- 25. Firmware TPM is version 2.0
- 26. HP Sure Click requires Windows 10 and supports Microsoft Internet Explorer, Google Chrome™, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
- 27. HP Sure Start Gen6 is available on select HP PCs.
- 28. HP Sure Run Gen3 is available on select Windows 10 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors.
- 29. HP Sure Recover Gen3 is available on select HP PCs and requires an open network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data.
- 30. HP Sure Sense requires Windows 10.

### **POWER**

### **Power Supply**

HP Smart 45 W External AC power adapter<sup>31</sup>

HP Smart 45 W External AC power adapter, 2-prong (Japan only) 31

HP Smart 65 W External AC power adapter<sup>31</sup>

HP Smart 65 W EM External AC power adapter<sup>31</sup>

65 Watt nPFC Slim USB-C Straight AC Adapter<sup>31</sup>

65 W USB Type-C® adapter<sup>31</sup>

### **Primary Battery**

HP Long Life 3-cell, 53 Wh Li-ion<sup>32,33</sup>

Support HP Fast Charge (Up to 50% in 30 minutes with 65W AC Adapter)<sup>34,35</sup>

### **Battery Life**

Up to 24 hours and 15 minutes<sup>35</sup>

#### **Power Cord**

2-wire plug - 1.0m31

3-wire plug - 1.0m31

- 31. Availability may vary by country.
- 33. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 34. Supports HP Fast Charge with 65W AC Adapter. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 35. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.



## **Technical Specifications**

### **WEIGHTS & DIMENSIONS**

### **Product Weight**

Non-touch

Starting at 2.78 lb <sup>36</sup> Starting at 1.26 kg<sup>36</sup>

Touch

Starting at 3.02 lb<sup>36</sup> Starting at 1.37 kg<sup>36</sup>

### Non-Touch, WLAN only

12.12 x 8.05 x 0.71 in 30.78 x 20.46 x 1.79 cm

### Touch, WLAN only

12.12 x 8.05 x 0.75 in 30.78 x 20.46 x 1.90 cm

### **WWAN**

12.12 x 8.05 x 0.75 in 30.78 x 20.46 x 1.91 cm

36. Weight will vary by configuration.

### **PORTS/SLOTS**

**Ports** 

2 USB Type-C® 3.1 Gen2 (Alt mode)

1 USB 3.1 Gen 1 port

1 USB 3.1 Gen 1 (1 charging)

1 HDMI 2.0<sup>6</sup>

1 headphone/microphone combo

1 AC power

1 SIM card slot<sup>37</sup>

1 Smartcard reader

6. HD content required to view HD images.

37. SIM slot is not user accessible without WWAN configuration.

### **SERVICE AND SUPPORT**



## **Technical Specifications**

HP Services offers 1-year or 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.<sup>38</sup>

38. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

### SYSTEM UNIT

Stand-Alone Power	Nominal Operating	19 V
Requirements (AC Power)	Voltage	
	<b>Average Operating Power</b>	2.82

Average Operating Power 2.82 W Integrated Graphics 6.78 W

Max Operating Power Discrete < 65W UMA < 45W

**Temperature**Operating
32° to 95° F (0° to 35° C) (not writing optical)
Non-operating
41° to 95° F (5° to 35° C) (writing optical)

**Relative Humidity Operating** 10% to 90%, non-condensing

**Non-operating** 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock Operating 40 G, 2 ms, half-sine
Non-operating 200 G, 2 ms, half-sine

Random Vibration Operating 0.75 grms

Non-operating 1.50 grms

Altitude (unpressurized) Operating -50 to 10,000 ft (-15.24 to 3,048 m)

**Non-operating** -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry StandardULYesCertificationsCSAYesFCC ComplianceYes

**ENERGY STAR®** Select models<sup>39</sup>

**EPEAT®** EPEAT® 2019 Gold in United States<sup>40</sup>

ICES Yes Australia / Yes

**NZ A-Tick Compliance** 

CCC Yes



## **Technical Specifications**

**Japan VCCI Compliance** Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance Yes (ICCP) **SABS** Yes

39. Configurations of the HP ProBook 650 G7 that are ENERGY STAR® qualified are identified as HP ProBook 650 G7 ENERGY STAR® on HP websites and on http://www.energystar.gov.

40. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.

### **DISPLAYS**

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP 1.2 w/o PSR bent NWBZ Outline Dimensions (W x H x D) 300.56 x 177.77 mm (max) (FPC folding included)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 260 g (max)
Diagonal Size 13.3 inch

Thickness 3.0 mm/ 5.0 mm (PCB) (max)

Interface eDP 1.2 (2 lane)
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio600:1 (typ)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED
Color Gamut Coverage NTSC 45%
Color Depth 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP

Outline Dimensions (W x H x D) 300.56 x 177.77 mm (max)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 260 g (max)

## **Technical Specifications**

1.2 w/o PSR bent Touch on Panel NWBZ

**Diagonal Size** 13.3 inch

Thickness 3.0 mm / 5.0 mm (PCB) (max)

Interface eDP 1.2

**Surface Treatment** Anti-Glare On - Cell

**Touch Enabled** Yes

Contrast Ratio600 :1 (typ)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe

Backlight LED

**Color Gamut Coverage** NTSC 45%

**Color Depth** 6 bits (Hi FRC supportive w/ condition to enable)

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA sRGB 100% NTSC 400 nits eDP 1.4+PSR2 bent LP NB2Y

Outline Dimensions (W x H x D) 299.06 x 176.54 mm (max) (FPC folding included)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 175 g (max)
Diagonal Size 13.3 inch

Thickness 2.0 mm / 3.8 mm (PCB) (max)
Interface eDP 1.4 w/ PSRII (2 lane)

**Surface Treatment** Anti-Glare

**Touch Enabled** No

Contrast Ratio 1500:1 (typ)
Refresh Rate 60 Hz
Brightness 400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe

Backlight LED

Color Gamut Coverage sRGB 100% (NTSC 72%)

Color Depth 8 bits

Viewing Angle UWVA 85/85/85

Panel LCD 13.3-in diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 72% NTSC 1000 nits eDP 1.4+PSR Sure View Reflect Outline Dimensions (W x H x D) 299.06 x 176.54 mm (max) (FPC folding included)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 220 g (max)

Diagonal Size 13.3 inch

Thickness 3.9 mm (max)



## **Technical Specifications**

Interface eDP 1.4 + PSR (4 lane)

**Surface Treatment** Anti-Glare (AG)

**Touch Enabled** No

Contrast Ratio 1500:1 (typ)
Refresh Rate 60 Hz
Brightness 1000 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Backlight LED

**Color Gamut Coverage** 72% of NTSC

**Color Depth** 8 bits

Viewing Angle UWVA 85/85/85

### **STORAGE**

SSD 128GB 2280 M2 SATA-3 TLC

Form Factor M.2 2280

**Capacity** 128 GB **NAND Type** TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

 Interface
 ATA-8, SATA 3.0

 Maximum Sequential Read
 550 ~ 560 MB/s

 Maximum Sequential Write
 380 ~ 530 MB/s

 Logical Blocks
 250,069,680

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

SSD 1TB 2280 PCIe-3x4 NVMe Form Factor Three Layer Cell single-sided

Form Factor M.2 2280

Capacity 1 TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

InterfacePCIe NVMe Gen3X4Maximum Sequential Read3100 ~ 3500 MB/sMaximum Sequential Write2770 ~ 3037 MB/sLogical Blocks2,000,409,264



## **Technical Specifications**

Operating Temperature

32° to 158°F (0° to 70°C) [ambient temp]

**Features** 

ATA Security; TRIM; L1.2

SSD 256GB 2280 M2 PCle-3x4 Form Factor

Form Factor

M.2 2280

SS NVMe TLC

Capacity 256 GB NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

InterfacePCIe NVMe Gen3X4Maximum Sequential Read2800 ~ 3500 MB/sMaximum Sequential Write1400 ~ 2200 MB/sLogical Blocks500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Value

Form Factor M.2 2280
Capacity 256 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

 Interface
 PCIe NVMe Gen3

 Maximum Sequential Read
 2100 ~ 2200 MB/s

 Maximum Sequential Write
 900 ~ 1400 MB/s

**Logical Blocks** 500, 118, 192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (optional); TRIM; L1.2

SSD 256GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer Cell Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)



## **Technical Specifications**

**Weight** 0.02 lb (10g)

InterfacePCIe NVMe Gen3X4Maximum Sequential Read2800 ~ 3500 MB/sMaximum Sequential Write1663 ~ 2200 MB/s

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

SSD 512GB 2280 M2 PCle-3x4 Form Factor SS NVMe TLC

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

InterfacePCIe NVMe Gen3X4Maximum Sequential Read3100 ~ 3500 MB/sMaximum Sequential Write2400 ~ 2956 MB/sLogical Blocks1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

 Interface
 PCIe NVMe Gen3

 Maximum Sequential Read
 2200 ~ 2300 MB/s

 Maximum Sequential Write
 1000 ~ 1600 MB/s

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (optional); TRIM; L1.2

Form Factor M.2 2280 Capacity 512 GB



SSD 512GB 2280 PCIe-3x4

## **Technical Specifications**

NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10g)

NVMe Self Encrypted OPAL2
Three Layer

Interface

PCIe NVMe Gen3X4

Maximum Sequential Read3100 ~ 3500 MB/sMaximum Sequential Write2400 ~ 2956 MB/sLogical Blocks1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.



## **Technical Specifications**

### **NETWORKING**

Intel® Wi-Fi 61 AX200 and Wireless LAN Standards IEEE 802.11a Bluetooth® 5.0 802.11 ax IEEE 802.11b (2x2) non-vPro, IEEE 802.11q supporting gigabit file IEEE 802.11n transfer speeds) non-IEEE 802.11ac vPro IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h

IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Wi-Fi CERTIFIED™ Interoperability

**Frequency Band** 802.11b/g/n/ax

> 2.402 - 2.482 GHz 802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

> • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

• 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup> IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode

only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

 WPA2 certification • IEEE 802.11i

WAPI

**Network Architecture** 

Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points Roaming

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum



## **Technical Specifications**

• 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
 802.11n HT40(2.4GHz): +14.5dBm minimum

• 802.11n HT20(5GHz): +15.5dBm minimum

• 802.11n HT40(5GHz): +14.5dBm minimum

• 802.11ac VHT80(5GHz): +11.5dBm minimum

802.11ac VHT160(5GHz): +11.5dBm minimum
802.11ax HT40(2.4GHz): +10dBm minimum

- 003 11 av //IIT1 CO/FCII-). + 10d Day animina

802.11ax VHT160(5GHz): +10dBm minimum

**Power Consumption** • Transmit mode 2.0 W

• Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)

• Connected Standby 10 mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/q, 6Mbps: -86dBm maximum

• 802.11a/g, 54Mbps: -72dBm maximum

• 802.11n, MCS07: -67dBm maximum

802.11n, MCS15: -64dBm maximum
802.11ac, MCS0: -84dBm maximum

• 802.11ac, MCS9: -59dBm maximum

802.11ax, MCS11(HT40): -59dBm maximum
 802.11ax, MCS11(VHT160): -58.5dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature Operating**  $14^{\circ}$  to  $158^{\circ}$  F ( $-10^{\circ}$  to  $70^{\circ}$  C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity Operating** 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity LED Amber** Radio Off

LED Off Radio On



## **Technical Specifications**

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

**Signaling Data Rate** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support

**Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

etooth Profiles BT4.1-ESR 5/6/7 Compliance

t**ed** LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising
LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 —Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for



## **Technical Specifications**

Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.

- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek	RTL	8822	CE
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802.11ac 2x2 Wi-Fi and Wireless LAN Standards Bluetooth® 5.0

IEEE 802.11a IEEE 802.11b

IEEE 802.11q

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i

IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability

Wi-Fi CERTIFIED™

**Frequency Band** 

• 802.11b/q/n

2.402 - 2.482 GHz

• 802.11a/n/ac

4.9 – 4.95 GHz (Japan)

5.15 - 5.25 GHz

5.25 - 5.35 GHz

5.47 - 5.725 GHz

5.825 - 5.850 GHz

**Data Rates** 

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation **Direct Sequence Spread Spectrum** 

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup>

IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode

only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification



## **Technical Specifications**

• IEEE 802.11i

WAPI

**Network Architecture** 

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

**Power Consumption** • Transmit mode 2.0 W

• Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby 10 mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum
802.11ac, MCS0: -84dBm maximum

• 802.11ac, MCS9: -59dBm maximum

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enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8g

2. Type 126: 1.3g

**Operating Voltage** 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (–10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity Operating** 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)



## **Technical Specifications**

LED Activity
LED Amber Radio Off
LED Off Radio On

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)

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BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

Power Management

Certifications

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management

Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode

LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 —Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.



## **Technical Specifications**

- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® XMM™ 7360 LTE-Advanced CAT9¹ Technology/Operating bands

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30),

1700/2100 (Band 66).

TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to

450Mbps; UL 20MHz throughput up to 50Mbps

**GPS** Standalone, A-GPS (MS-A, MS-B)

**GPS bands** 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098

MHz

Maximum data rates LTE: 450 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power

LTE: 23 dBm

HSPA+: 23.5 dBm

42 x 30 x 2.3 mm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 5.8 g

Dimensions

(Length x Width x Thickness)

nath x Width x

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Near Field Communications Controller (optional) Dimensions (L x Wx H)

Module 25 mm by 10 mm by 2.0 mm

Chipset NPC100
System interface I2C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B 1.8ISO/IEC 15693



## **Technical Specifications**

ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-

ISO/IEC 14443 A

VICC) Mode

ISO/IEC 14443 B and B'

MIFARE

FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer

**Raw RF Data Rates** 106, 212, 424, 848 kbps

**Operating temperature** 0°C to 70°C **Storage temperature** -20°C to 125°C

**Humidity** 10-90% operating

5-95% non-operating

**Supply Operating voltage** 4.35 to 5.25 Volts

**I/O Voltage** 1.8V or 3.3V

**Power Consumption** 

(Booster enable, VBAT= 3.3V, VCC\_BOOST = 5V)

Mode Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

**Antenna** Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module

## **Technical Specifications**

### **POWER**

AC Adapter 45 Watt **Smart nPFC Standard** Barrel 4.5mm Right Angle 1.8m

**Dimensions** 95 x 45 x 26.8 mm Weight unit: 200g +/- 10g Input

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output **Output power** 45W

> DC output 19.5V

Hold-up time 5ms at 115 Vac input

**Output current limit** <8.0A

Connector **Environmental Design** 

Connector 4.5 mm Barrel Type Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage)

-4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

**Safety Certifications** 

\*CE Mark - full compliance with LVD and EMC directives

\*Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B.

FCC Class B. CISPR22 Class B. CCC. NOM-1 NYCE.

\*MTBF - over 200.000 hours at 25°C ambient condition.

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 2prong

**Dimensions** 95 x 45 x 26.8 mm Weight unit: 200g +/- 10g Input

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output **Output power** 45W **DC** output 19.5V

Hold-up time 5ms at 115 Vac input

**Output current limit** <8.0A

Connector Connector 4.5 mm Barrel Type

**Environmental Design Operating temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage)

-4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**Safety Certifications** 

\*CE Mark - full compliance with LVD and EMC directives

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FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\*MTBF - over 200,000 hours at 25°C ambient condition.



## **Technical Specifications**

AC Adapter 65 Watt nPFC Dimensions Slim USB Type-C® Weight Straight 1.8m

Dimensions 88 x 53.5 x 21 mm
Weight unit: 220g +/- 10g
Input Input Efficiency

Efficiency

81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A

88% min at 115 Vac/ 230Vac @ 12V/5A

89% min at 115 Vac/ 230Vac @ 15V/4.33A

89% min at 115 Vac/ 230Vac @ 20V/3.25A

**Input frequency range** 47 ~ 63 Hz

**Input AC current** 1.6 A at 90 VAC and maximum load

Output Output power 65W

**DC output** 5V/9V/12V/15V/20V **Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A
Connector USB Type C®

Connector Connector USB Type C®

Environmental Design Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage) temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity5% to 95%Storage Humidity5% to 95%

**Safety Certifications** Eg:

\*CE Mark - full compliance with LVD and EMC directives

\*Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

-4°F to 185°F (-20°to 85°C)

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.
\*MTBF - over 100,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Dimensions Slim USB Type-C® Weight Straight 1.8m

 Dimensions
 90.0 x 51 x 28.5 mm

 Weight
 unit: 250g +/- 10g

 Input
 Input Efficiency

Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A

89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

**Input frequency range** 47 ~ 63 Hz

**Input AC current** 1.6 A at 90 VAC and maximum load

Output Output power 65W

**DC output** 5V/9V/12V/15V/20V **Hold-up time** 5ms at 115 Vac input

Output current limit 8.0A

Connector Connector USB Type C®

**Environmental Design Operating temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)



## **Technical Specifications**

**AC Adapter 65 Watt** Smart nPFC EM Barrel 4.5mm New EM

**Dimensions** 102 x 55 x 30 mm Weight unit: 220g +/- 10g

Input **Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

> Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.7 A at 90 Vac

Output **Output power** 65W

> DC output 19.5V

Hold-up time 5ms at 115 Vac input

**Output current limit** <11.0A

Connector Connector 4.5 mm Barrel Type **Environmental Design** Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

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FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\*MTBF - over 200,000 hours at 25°C ambient condition.

**AC Adapter 65 Watt** Smart nPFC Standard **Barrel 4.5mm Right Angle** 1.8m

**Dimensions** 90 x 51 x 28.5 mm Weight unit: 230g +/- 10g

Input **Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

> 47 ~ 63 Hz Input frequency range

**Input AC current** Max. 1.7 A at 90 Vac

**Output Output power** 65W

> DC output 19.5V

Hold-up time 5ms at 115 Vac input

**Output current limit** <11.0A

Connector Connector 4.5 mm Barrel Type

**Environmental Design** Operating temperature 32°F to 95°F (0°to 35°C) -4°F to 185°F (-20°to 85°C)

Non-operating (storage)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

**Safety Certifications** Eg:

\*CE Mark - full compliance with LVD and EMC directives

\*Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B. CISPR22 Class B. CCC. NOM-1 NYCE. \*MTBF - over 200,000 hours at 25°C ambient condition.

## **Technical Specifications**

Battery CC 3 Cell WHr 53 Long Life -PL Fast Charge

7.3 x 52.9 x 267.11 mm Dimensions (H x W x L)

0.287 x 2.082 x 10.516 inch

Weight 0.45 lb

Cells/Type 3cell Lithium-Ion Polymer cell / 645180 Voltage 11.55V Energy

4.59Ah **Amp-hour capacity** 

**Watt-hour capacity** 53Wh 32° to 113° F (0° to 45°C)

**Operating (Charging) Operating (Discharging)** 14° to 122° F (-10° to 60°C)

Warranty Depends on system offering

**Optional Travel Battery** 

Available

**Temperature** 

No



## Technical Specifications

### **COUNTRY OF ORIGIN**

China



## Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
	Description	Part Number
Type Cases	HP Business Backpack (up to 17.3")	2SC67AA
cases	HP Business Case(up to 15.6")	2SC66AA
	HP Business Slim Top Load (up to 14.1" x .75" thick)	2SC65AA
	HP Essential Top Load Case (up to 15.6")	H2W17AA
Docking	HP Thunderbolt Dock 120W G2	2UK37AA
Input/Output	HP Thunderbolt Dock 230W G2	2UK38AA
	HP Thunderbolt Dock 120W G2 TAA	2UK37AA
	HP TB Dock Audio Module	3AQ21AA
	HP TB Dock 120W G2 cable	3XB94AA
	HP TB Dock G2 combo cable	3XB96AA
	HP USB-C Mini Dock	1PM64AA
	HP USB-C Dock G5	5TW10AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Wireless (Link-5) Keyboard	T6U20AA
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP USB Collaboration Keyboard	Z9N38AA
	HP Wireless Collaboration Keyboard	Z9N39AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP X4000b Bluetooth Mouse	H3T50AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
Power	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Wireless Premium Mouse	1JR31AA
	HP USB Premium Mouse	1JR32AA
	HP Essential USB Mouse	2TX37AA
	HP Elite Presenter Mouse	2CE30AA
Storage	HP Bluetooth Travel Mouse	6SP30AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP UC Wireless Mono Headset	W3K08AA
Security	HP UC Wireless Duo Headset	W3K09AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP USB-C to DP	N9K78AA



## **Summary of Changes**

Date of change:	Version History:	Updated	Description of change:
	V1 to V2		

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